MUR405, MUR410, MUR415, MUR420, MUR440, MUR460

MUR420 and MUR460 are Preferred Devices

SWITCHMODE™ Power Rectifiers

. . . designed for use in switching power supplies, inverters and as free wheeling diodes, these state−of−the−art devices have the following features:

- Ultrafast 25, 50 and 75 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- Reverse Voltage to 600 Volts

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16″ from case
- Shipped in plastic bags, 5,000 per bag
- Available Tape and Reeled, 1500 per reel, by adding a “RL’’ suffix to the part number
- Polarity: Cathode indicated by Polarity Band
- Marking: MUR405, MUR410, MUR415, MUR420, MUR440, MUR460

MAXIMUM RATINGS

Please See the Table on the Following Page

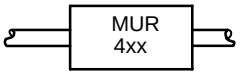
ON Semiconductor®

http://onsemi.com

ULTRAFAST RECTIFIERS
4.0 AMPERES
50−600 VOLTS

AXIAL LEAD
CASE 267−05
(DO−201AD)
STYLE 1

MARKING DIAGRAM



MUR4xx = Device Code
xx = 05, 10, 15, 20, 40, 60

ORDERING INFORMATION

Device	Package	Shipping
MUR405	Axial Lead	5000 Units/Bag
MUR405RL	Axial Lead	1500/Tape & Reel
MUR410	Axial Lead	5000 Units/Bag
MUR410RL	Axial Lead	1500/Tape & Reel
MUR415	Axial Lead	5000 Units/Bag
MUR415RL	Axial Lead	1500/Tape & Reel
MUR420	Axial Lead	5000 Units/Bag
MUR420RL	Axial Lead	1500/Tape & Reel
MUR440	Axial Lead	5000 Units/Bag
MUR440RL	Axial Lead	1500/Tape & Reel
MUR460	Axial Lead	5000 Units/Bag
MUR460RL	Axial Lead	1500/Tape & Reel

Preferred devices are recommended choices for future use and best overall value.

MAXIMUM RATINGS

Rating	Symbol	MUR 405	MUR 410	MUR 415	MUR 420	MUR 440	MUR 460	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	50	100	150	200	400	600	Volts
Average Rectified Forward Current (Square Wave) (Mounting Method #3 Per Note 2)	$I_{F(AV)}$	4.0 @ T_A = 80°C				4.0 @ T_A = 40°C		Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, half wave, single phase, 60 Hz)	I_{FSM}	125				110		Amps
Operating Junction Temperature & Storage Temperature	T_J, T_{stg}	−65 to +175						°C

THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	See Note 2	°C/W

ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 1) (i_F = 3.0 Amps, T_J = 150°C) (i_F = 3.0 Amps, T_J = 25°C) (i_F = 4.0 Amps, T_J = 25°C)	v_F	 0.710 0.875 0.890	 1.05 1.25 1.28	Volts
Maximum Instantaneous Reverse Current (Note 1) (Rated dc Voltage, T_J = 150°C) (Rated dc Voltage, T_J = 25°C)	i_R	 150 5.0	 250 10	μA
Maximum Reverse Recovery Time (I_F = 1.0 Amp, di/dt = 50 Amp/μs) (I_F = 0.5 Amp, i_R = 1.0 Amp, I_{REC} = 0.25 Amp)	t_{rr}	 35 25	 75 50	ns
Maximum Forward Recovery Time (I_F = 1.0 A, di/dt = 100 A/μs, Recovery to 1.0 V)	t_{fr}	25	50	ns

1. Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

MUR405, MUR410, MUR415, MUR420

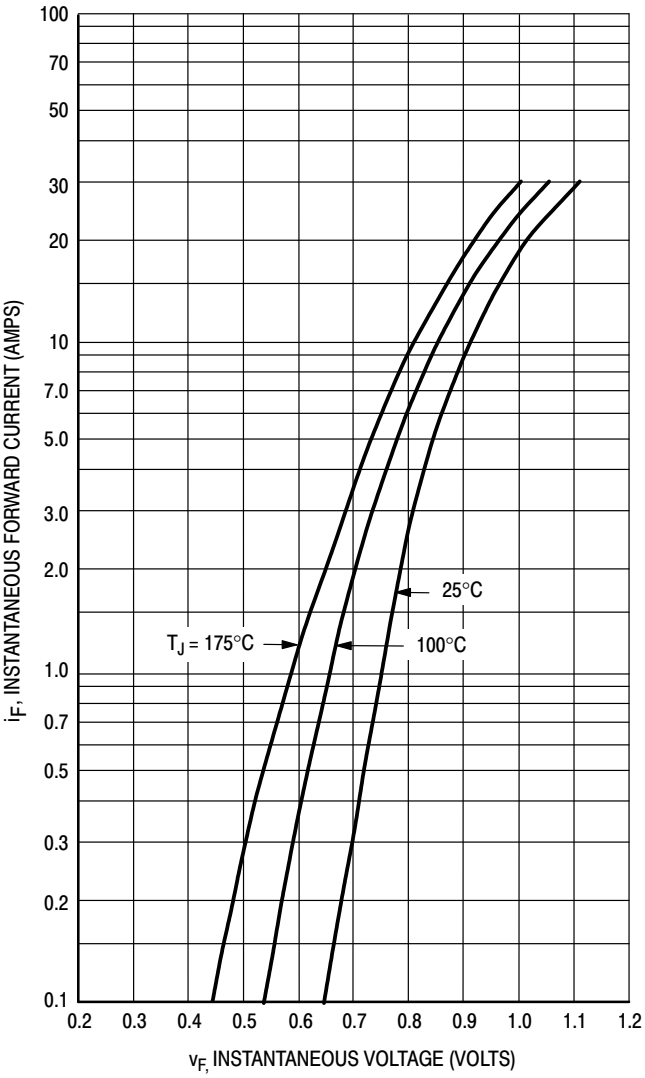


Figure 1. Typical Forward Voltage

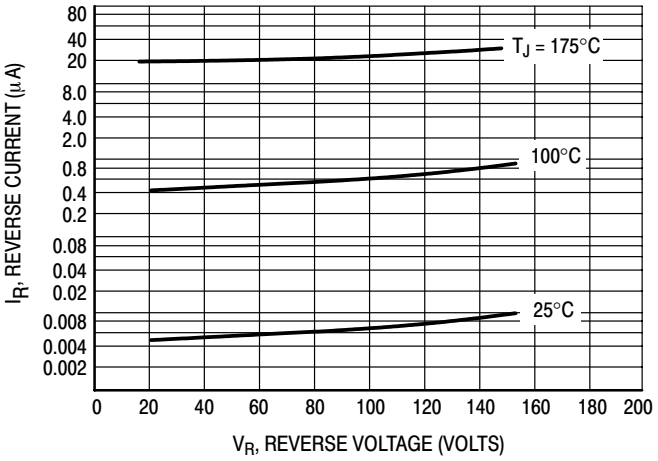


Figure 2. Typical Reverse Current

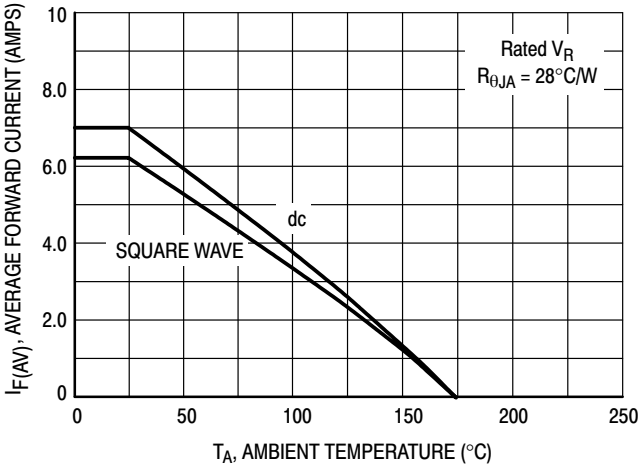


Figure 3. Current Derating (Mounting Method #3 Per Note 2)

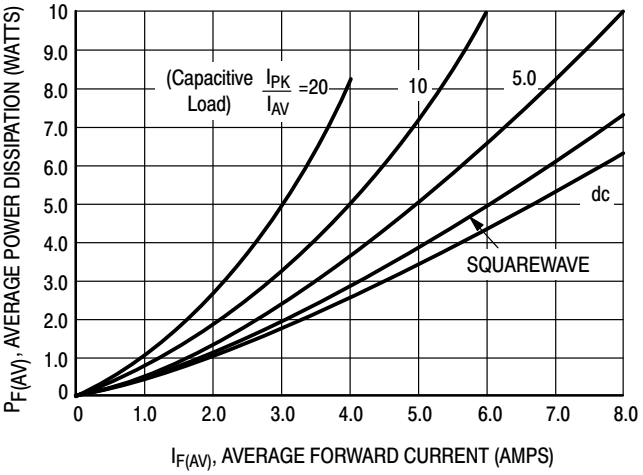


Figure 4. Power Dissipation

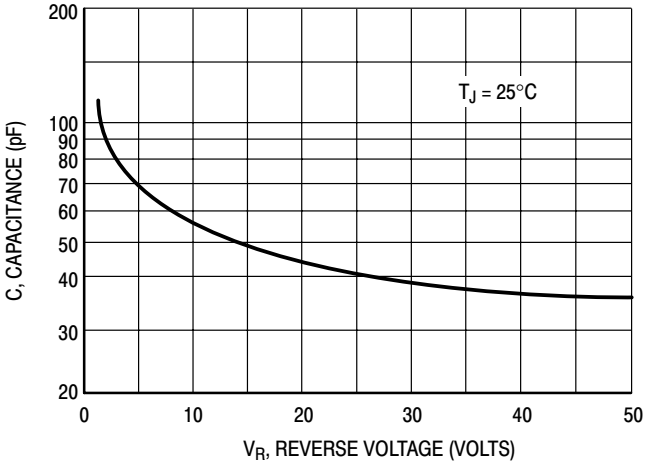


Figure 5. Typical Capacitance

MUR440, MUR460

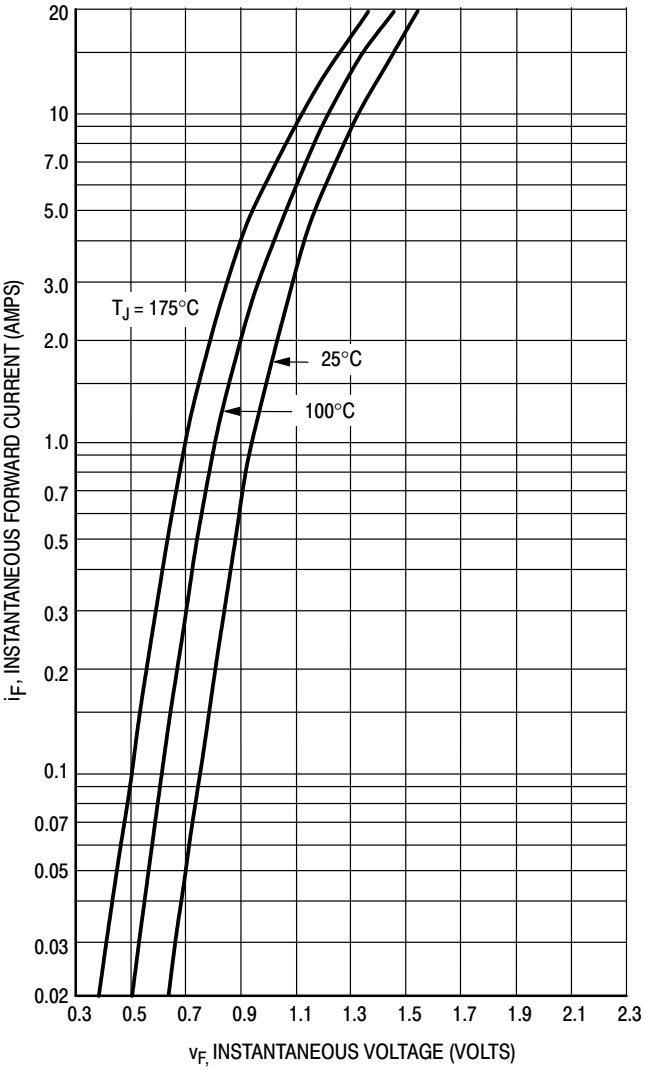


Figure 6. Typical Forward Voltage

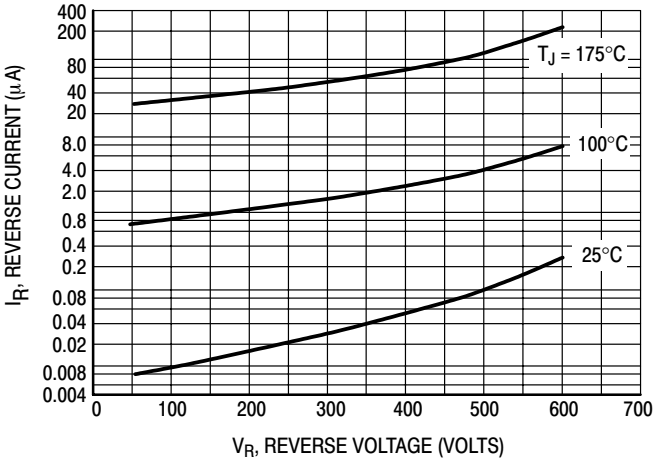


Figure 7. Typical Reverse Current

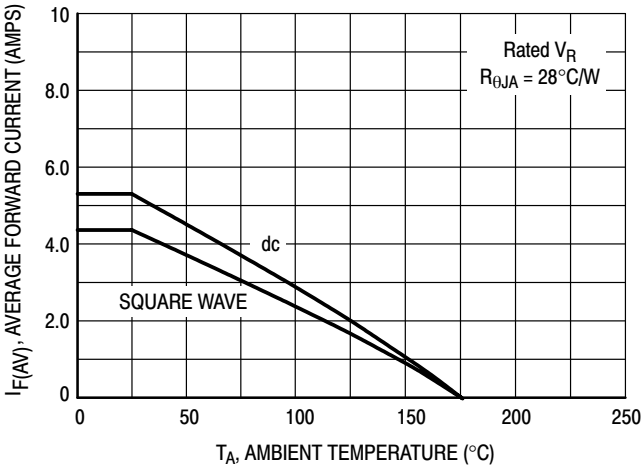


Figure 8. Current Derating (Mounting Method #3 Per Note 2)

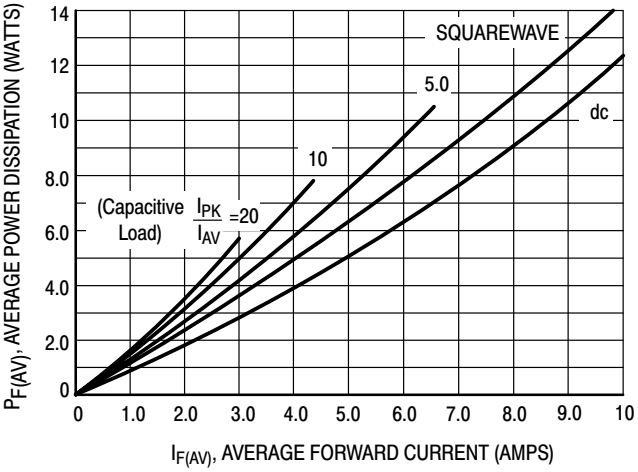


Figure 9. Power Dissipation

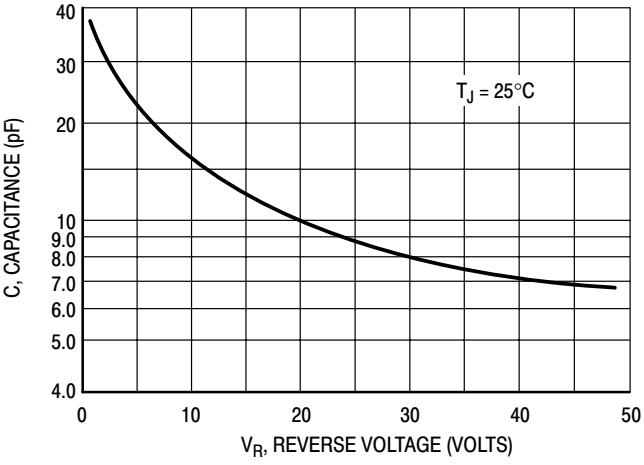


Figure 10. Typical Capacitance

NOTE 2 — AMBIENT MOUNTING DATA

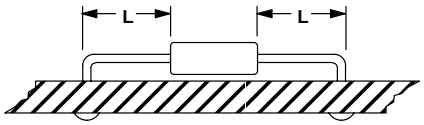
Data shown for thermal resistance junction−to−ambient ($R_{\theta JA}$) for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

TYPICAL VALUES FOR $R_{\theta JA}$ IN STILL AIR

Mounting Method		Lead Length, L (IN)				Units
		1/8	1/4	1/2	3/4	
1	$R_{\theta JA}$	50	51	53	55	°C/W
2		58	59	61	63	°C/W
3		28				°C/W

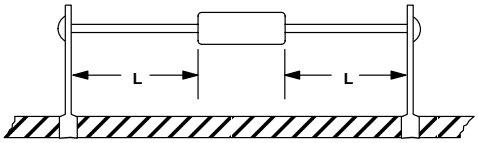
MOUNTING METHOD 1

P.C. Board Where Available Copper Surface area is small.



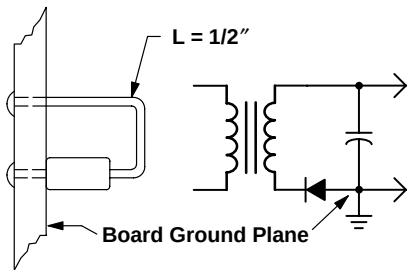
MOUNTING METHOD 2

Vector Push−In Terminals T−28



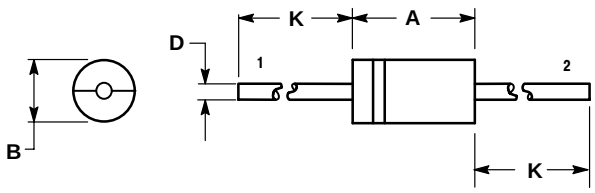
MOUNTING METHOD 3

P.C. Board with 1−1/2″ x 1−1/2″ Copper Surface



PACKAGE DIMENSIONS

AXIAL LEAD
CASE 267−05
(DO−201AD)
ISSUE G



NOTES:
1. DIMENSIONS AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. 267−04 OBSOLETE, NEW STANDARD 267−05.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.287	0.374	7.30	9.50
B	0.189	0.209	4.80	5.30
D	0.047	0.051	1.20	1.30
K	1.000	---	25.40	---

STYLE 1:
PIN 1. CATHODE (POLARITY BAND)
2. ANODE

PUBLICATION ORDERING INFORMATION

Literature Fulfillment:
Literature Distribution Center for ON Semiconductor
P.O. Box 5163, Denver, Colorado 80217 USA
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